ᶜ(UL)ᵤₛ BICSI/TIA-607-B Telecommunications Grounding Busbars
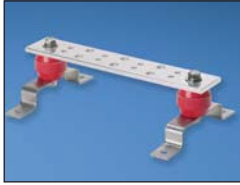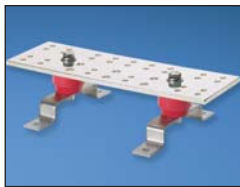
- Meet BICSI and TIA-607-B requirements for network systems grounding applications
- Made of high conductivity copper and tin-plated to inhibit corrosion

- Come pre-assembled with brackets and insulators attached for quick installation
- Use Panduit component labels, sold separately, to identify busbars to meet TIA/EIA-606-A, see chart below

TGB

TMGB

| Part Number | Bar Size | No. of Mounting Positions | | Std. Pkg. Qty. |
		1/4" Stud Hole with 5/8" Hole Spacing	3/8" Stud Hole with 1" Hole Spacing	
Telecommunications Grounding Busbars (TGB)				
GB2B0304TPI-1	1/4" x 2" x 10"	4	3	1
GB2B0306TPI-1	1/4" x 2" x 12"	6	3	1
GB2B0312TPI-1	1/4" x 2" x 20"	12	3	1
GB2B0514TPI-1	1/4" x 2" x 24"	14	5	1
Telecommunications Main Grounding Busbars (TMGB)				
GB4B0612TPI-1	1/4" x 4" x 12"	12	6	1
GB4B0624TPI-1	1/4" x 4" x 20"	24	6	1
GB4B1028TPI-1	1/4" x 4" x 24"	28	10	1

Telecommunications Grounding and Bonding Conductor Label Kit

Part Number	Part Description	Std. Pkg. Qty.
LTYK	Label kit includes printed tag and one flame retardant cable tie.	1

For complete labeling solutions and product information, reference charts on pages O.1 – O.18.

Component Labels for BICSI/TIA-607-B Telecommunications Grounding Busbars

1A-TMGB

| Telecommunications Grounding Busbar Part Number | Suggested Label Solutions for TIA/EIA-606-A Compliance | | | |
	Laser/Ink Jet Desktop Printer Label	TDP43ME Thermal Transfer Desktop Printer Label	PanTher™ LS8E Hand-Held Printer Label	Cougar™ LS9 Hand-Held Printer Label
All GB2B and GB4B Parts	C200X100FJJ	C200X100YPT	C200X100FJC	T100X000VPC-BK